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40 V PNP low V_{CEsat} (BISS) transistor Rev. 02 — 14 December 2009

Product data sheet

1. Product profile

1.1 General description

PNP low V_{CEsat} Breakthrough in Small Signal (BISS) single bipolar PNP transistor in a SOT457 (SC-74) SMD plastic package.

NPN complement: PBSS4440D.

1.2 Features

- Ultra low collector-emitter saturation voltage V_{CEsat}
- 4 A continuous collector current capability I_C (DC)
- Up to 15 A peak current
- Very low collector-emitter saturation resistance
- High efficiency due to less heat generation

1.3 Applications

- Power management functions
- Charging circuits
- DC-to-DC conversion
- MOSFET gate driving
- Power switches (e.g. motors, fans)
- Thin Film Transistor (TFT) backlight inverter

1.4 Quick reference data

Table 1. Quick reference data Symbol Parameter Conditions Min Тур Max Unit V_{CEO} collector-emitter voltage open base --40 V _ [1] _ I_{C} collector current (DC) -4 А peak collector current t = 1 ms or limited by -15 А -I_{CM} -T_{j(max)} [2] _ $\mathsf{R}_{\mathsf{CEsat}}$ collector-emitter saturation $I_{\rm C} = -6 \, {\rm A};$ 55 75 mΩ resistance $I_{B} = -600 \text{ mA}$

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), AL₂O₃, standard footprint.

Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$. [2]



40 V PNP low V_{CEsat} (BISS) transistor

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Symbol
1	collector		
2	collector		1, 2, 5, 6
3	base	0	3
4	emitter		Ĵ
5	collector		4 sym030
6	collector		

3. Ordering information

Table 3. Orderi	ng informatio	on	
Type number	Package		
	Name	Description	Version
PBSS5440D	SC-74	plastic surface mounted package; 6 leads	SOT457

4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
PBSS544	D	71

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	-40	V
V _{CEO}	collector-emitter voltage	open base	-	-40	V
V _{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current (DC)		<u>[1]</u> _	-4	А
I _{CM}	peak collector current	t = 1 ms or limited by $T_{j(max)}$	-	-15	А
I _B	base current (DC)		-	-0.8	А
I _{BM}	peak base current	$t_p \le 300 \ \mu s$	-	-2	А
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[2] _	360	mW
			[3] _	600	mW
			[4] _	750	mW
			<u>[1]</u> -	1.1	W
			[2][5]	2.5	W

40 V PNP low V_{CEsat} (BISS) transistor

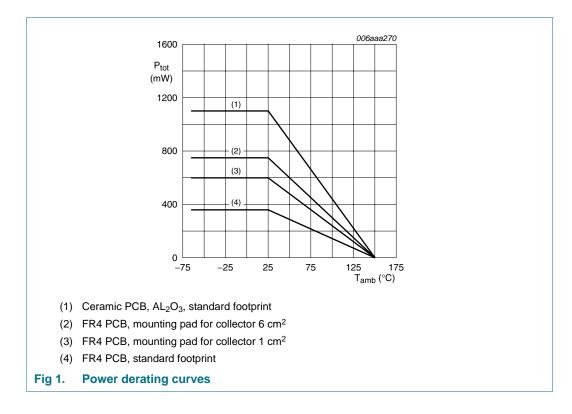
Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

[1] Device mounted on a ceramic PCB, AL_2O_3 , standard footprint.

- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².
- [4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².
- [5] Operated under pulsed conditions: Duty cycle $\delta \leq$ 10% and pulse width $t_p \leq$ 10 ms.



40 V PNP low V_{CEsat} (BISS) transistor

6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	350	K/W
			[2] _	-	208	K/W
			[3] _	-	160	K/W
			[4] _	-	113	K/W
			<u>[1][5]</u>	-	50	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	45	K/W

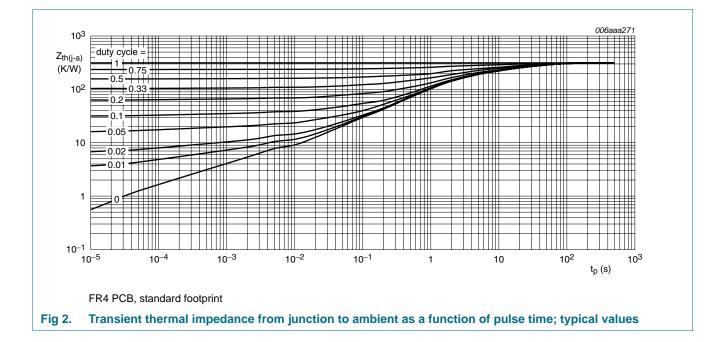
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

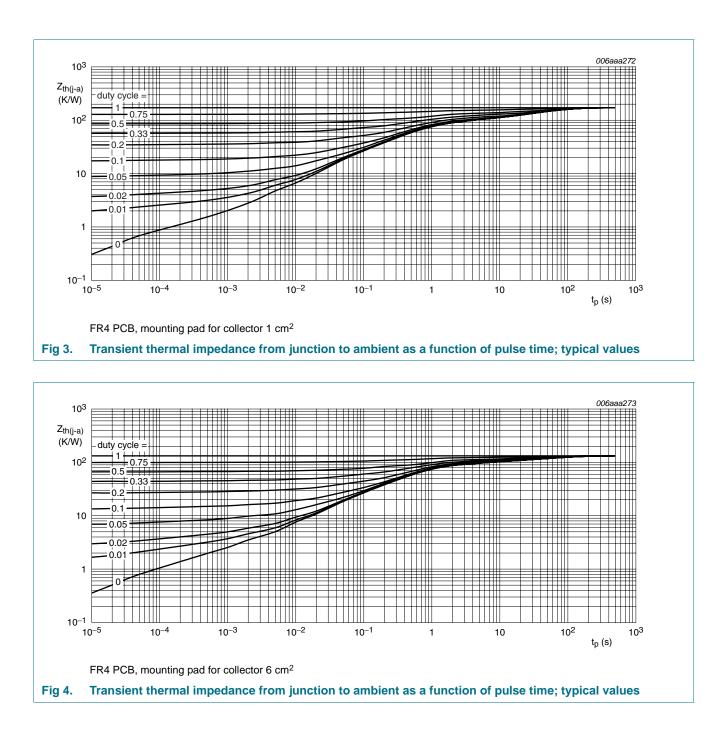
[4] Device mounted on a ceramic PCB, AL_2O_3 , standard footprint.

[5] Operated under pulsed conditions: Duty cycle $\delta \leq$ 10% and pulse width $t_p \leq$ 10 ms.



PBSS5440D

40 V PNP low V_{CEsat} (BISS) transistor



40 V PNP low V_{CEsat} (BISS) transistor

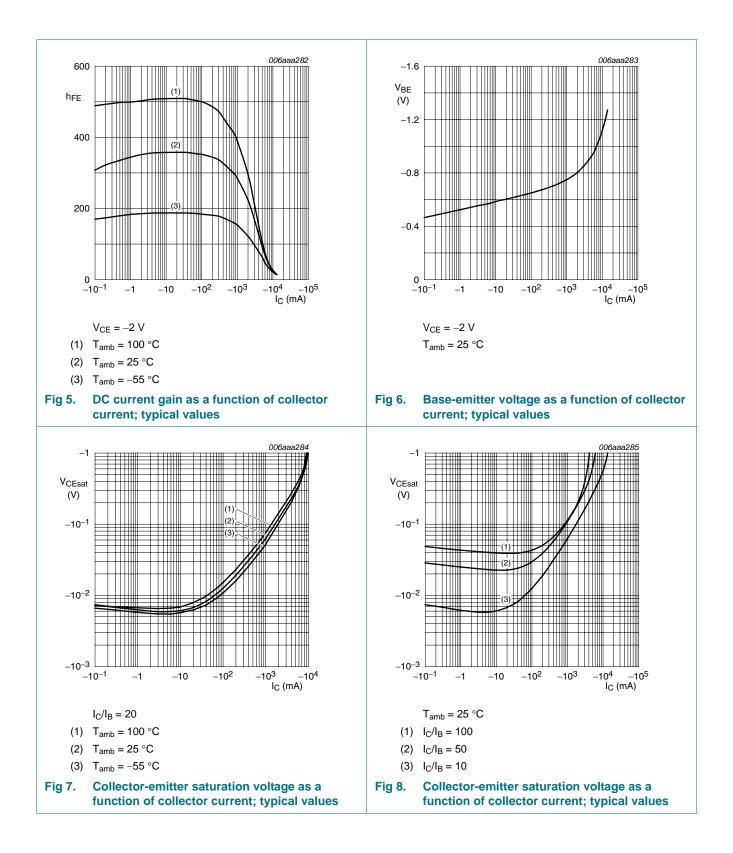
7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = -30 \text{ V}; I_E = 0 \text{ A}$		-	-	-0.1	μΑ
	current	V_{CB} = -30 V; I _E = 0 A; T _j = 150 °C		-	-	-50	μΑ
I _{CES}	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; V_{BE} = 0 \text{ V}$		-	-	-0.1	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	-0.1	μΑ
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -0.5 \text{ A}$		200	-	-	
		$V_{CE} = -2 V; I_C = -1 A$	<u>[1]</u>	200	-	-	
		$V_{CE} = -2 V; I_C = -2 A$	<u>[1]</u>	175	-	-	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -4 \text{ A}$	<u>[1]</u>	80	-	-	
		$V_{CE} = -2 V; I_C = -6 A$	<u>[1]</u>	30	-	-	
V _{CEsat}	collector-emitter	$I_{C} = -0.5 \text{ A}; I_{B} = -50 \text{ mA}$		-	-46	-60	mV
satu	saturation voltage	$I_{C} = -1$ A; $I_{B} = -50$ mA		-	-70	-110	mV
		$I_{\rm C} = -2$ A; $I_{\rm B} = -200$ mA		-	-120	-180	mV
		$I_{C} = -4 \text{ A}; I_{B} = -400 \text{ mA}$	[1]	-	-220	-300	mV
		$I_{\rm C} = -6$ A; $I_{\rm B} = -600$ mA	[1]	-	-320	-450	mV
R _{CEsat}	collector-emitter saturation resistance	$I_{C} = -6 \text{ A}; I_{B} = -600 \text{ mA}$	<u>[1]</u>	-	55	75	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_{C} = -0.5 \text{ A}; I_{B} = -50 \text{ mA}$		-	-0.8	-0.85	V
		$I_{C} = -1 \text{ A}; I_{B} = -50 \text{ mA}$		-	-0.84	-0.9	V
		$I_{C} = -1 \text{ A}; I_{B} = -100 \text{ mA}$	[1]	-	-0.84	-1	V
		$I_{C} = -4 \text{ A}; I_{B} = -400 \text{ mA}$	[1]	-	-1.0	-1.1	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -2 \text{ A}$		-	-0.8	-1.0	V
d	delay time	$V_{CC} = -10 \text{ V}; I_C = -2 \text{ A};$		-	12	-	ns
tr	rise time	$I_{Bon} = -0.1 \text{ A}; I_{Boff} = 0.1 \text{ A}$		-	43	-	ns
t _{on}	turn-on time			-	55	-	ns
s	storage time			-	240	-	ns
ŕ	fall time			-	80	-	ns
off	turn-off time			-	320	-	ns
T	transition frequency	$V_{CE} = -10 \text{ V}; \text{ I}_{C} = -0.1 \text{ A};$ f = 100 MHz		-	110	-	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz		-	50	-	pF

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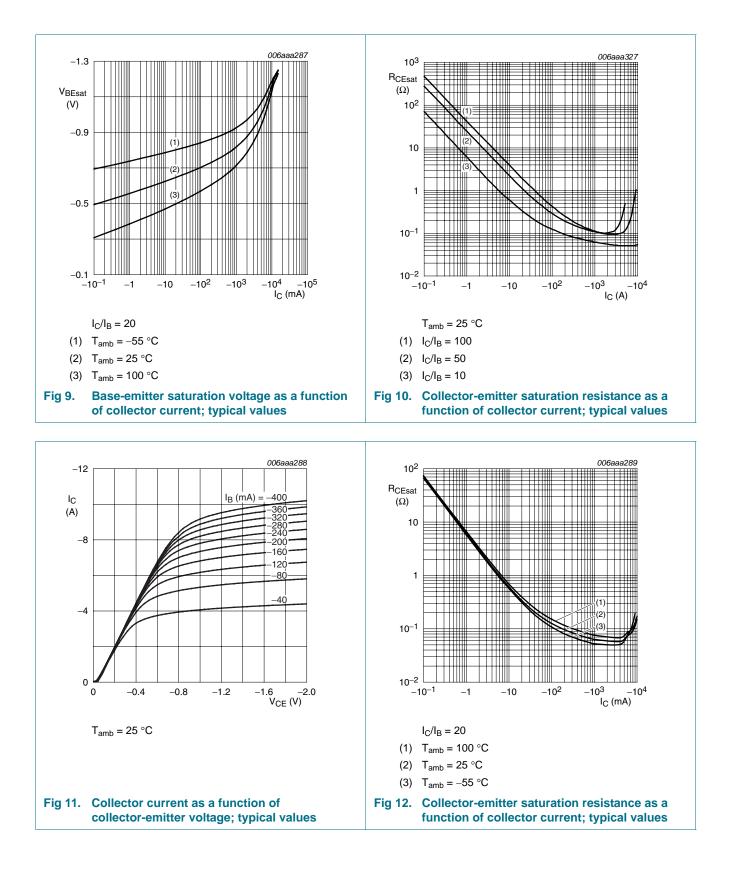
PBSS5440D

40 V PNP low V_{CEsat} (BISS) transistor



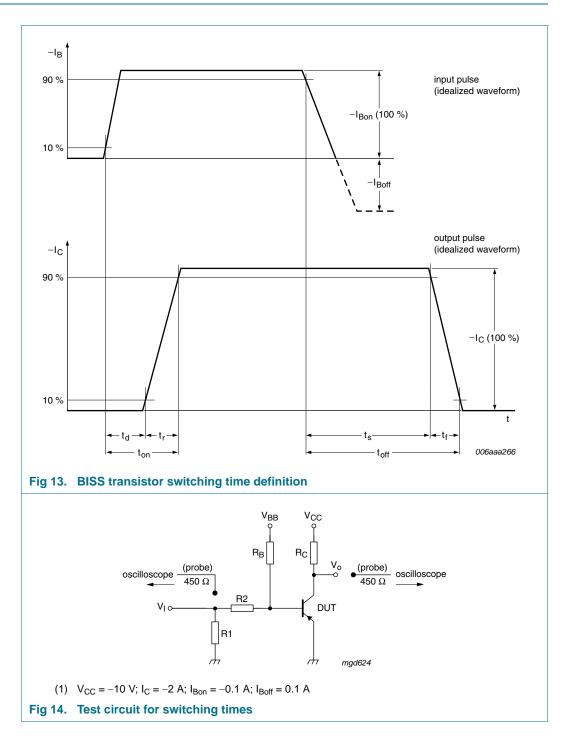
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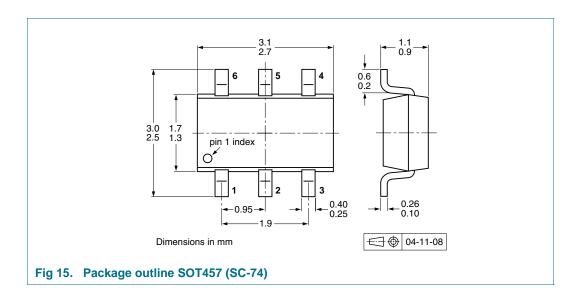
40 V PNP low V_{CEsat} (BISS) transistor

8. Test information



40 V PNP low V_{CEsat} (BISS) transistor

9. Package outline



10. Packing information

Table 8.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	pe number Package Description P		Description		ity	
				3000	5000	10000
PBSS5440D	SOT457	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-	-165

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

[2] T1: normal taping

[3] T2: reverse taping

40 V PNP low V_{CEsat} (BISS) transistor

11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
PBSS5440D_2	20091214	Product data sheet	-	PBSS5440D_1			
Modifications:	 This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content. 						
	 Figure 2 "Tra typical value 		from junction to ambier	nt as a function of pulse time			
	 Figure 3 "Transient thermal impedance from junction to ambient as a function of pulse time; typical values": updated 						
	 Figure 4 "Tra typical values 	nt as a function of pulse time					
	 Figure 6 "Bas 	se-emitter voltage as a fun	ction of collector curren	nt; typical values": updated			
	 Figure 11 "Coupdated 	ollector current as a function	on of collector-emitter v	oltage; typical values":			
PBSS5440D 1	20050427	Product data sheet					

40 V PNP low V_{CEsat} (BISS) transistor

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PBSS5440D_2

PBSS5440D

40 V PNP low V_{CEsat} (BISS) transistor

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